



Docket No.: M4065.0374/P374
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Mike Brooks

RECEIVED

Application No.: 09/760,741

Art Unit: 2815

FEB 27 2004

Filed: January 17, 2001

Examiner: C. C. Chu

For: SEMICONDUCTOR ASSEMBLY
WITHOUT ADHESIVE FILLETS

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated December 30, 2003, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 9 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Amendments to the Specification begin on page 10 of this paper

Remarks begin on page 11 of this paper.

An **Appendix** including amended drawing figures is attached following page 23 of this paper.